1 Introduction

1.1 History

JEDEC REGISTERED AND STANDARD OUTLINES FOR SEMICONDUCTOR DEVICES, JEDEC PUBLICATION 95, is the official JEDEC Publication that contains the registered or standard mechanical outlines of solid state products and related items. The introduction of this document states:

"The primary purpose of solid state products outline registration is to assure complete mechanical interchangeability of all products conforming to a particular outline regardless of when or from whom it was obtained."

The reality of the situation is that the Publication 95 outlines have become "umbrellas" or "catchalls" in order to accommodate the various nominal dimensions of different manufacturers. The effect has been to increase tolerances to the point that they reflect large size variations rather than small variations around a common nominal or mean dimension. Another factor has been the attempt on the part of the manufacturers to use the largest possible tolerances in order to allow production to proceed at high speed and high volume.

From a component production point of view, the use of wide tolerances is an economically desirable goal. From a system point of view, such use results in the transfer of costs to the user who has to accommodate the large tolerances. The user is also limited in the selection of vendors because of a lack of complete interchangeability of the products of different manufacturers.

1.2 Authority

Recognizing these problems, the EIA/JEDEC Council authorized the formation of the Design Handbook (DHB) Committee to operate under the cognizance of the JC-11 Committee on Mechanical Standardization. The Committee was charged to establish criteria that will:

- Reduce the PROLIFERATION of outlines
- Provide FUNCTIONAL semiconductor package and related part outlines that will be the basis for PROCUREMENT documents specifying nominal dimensions, realistic tolerances and quality requirements for all outlines.

JEDEC Standard 95-1, hereinafter known as the DESIGN HANDBOOK, will establish guideline methods for obtaining the desired dimensions and tolerancing for various classes of packages and related items. This Handbook will be updated on a regular basis as new packages are developed.
1 Introduction (cont’d)

1.3 Task force formation

During its Fall 1987 meeting the JC-11 Chairman authorized the formation of a Task Group, which subsequently became the JC-11.2 Design Requirements Committee, with the goal of producing this Handbook.

1.4 Applicable documents

The basic reference for outline drawings in the DESIGN HANDBOOK is:

    ANSI Y14.5M-1982, "Dimensioning and Tolerancing"

Where there is a difference between the ANSI Y14.5M-1982 and the Design Handbook with respect to definitions, applications etc., the DESIGN HANDBOOK shall take precedence.

1.4.1 Additional references

When the following American National Standards referred to in this document are superseded by a revision approved by the American National Standards Institute, Inc., the revision shall apply.

− ANSI B4.2-1978, Preferred Metric Limits and Fits
− ANSI B46.1-1978, Surface Texture
− ANSI B87.1-1965, Decimal Inch
− ANSI B89.3.1-1972, Measurement of Out-of-Roundness
− ANSI Y14.2M-1979, Line Conventions and Lettering
− ANSI Y14.6-1978, Screw Thread Representation
− ANSI Y14.36-1978, Surface Texture Symbols
− ANSI Z210.1-1976, Metric Practice